

ITEM :

CRYSTAL OSCILLATOR

TYPE :

DSA221SDN

NOMINAL FREQUENCY :

10.000MHz

SPEC No. :

1XXA10000MCA

If there is a change in this specifications, the specification number may be changed.

	RECEIPT
DATE	
RECEIVED	(signature) (name)



- 1. Device Name VC-TCXO
- 2. Model Name DSA221SDN
- 3. Nominal Frequency 10.000 MHz
- 4. Mass 0.02g max.

5. Absolute Maximum Ratings

	Item	Symbol		Rating		unit
1	Supply Voltage	Vcc	-0.3~+4.6			V
2	Storage Temperature Range	T_ _{STG}	-40~+85			°C
6. Recommended Operating Conditions						
	Item	Symbol	min.	typ.	max.	unit
1	Supply Voltage	V _{CC}	+2.85	+3.0	+3.15	V
2	Load Impedance (resistance part)	$L_{OAD}R$	9	10	11	kΩ
	(parallel capacitance)	L _{OAD} _C	9	10	11	pF
3	Control Voltage Range	V _{CONT}	+0.5	+1.5	+2.5	V
4	Operating Temperature Range	T_OPR	-40	-	+85	°C

7. Electrical Characteristics

 $(T_{A}=-40 \sim +85^{\circ}C, L_{OAD}_R//C=10 k\Omega//10 pF, V_{CC}=+3.0V, V_{CONT}=+1.5V, unless otherwise noted)$

	Item Conditions			Limits			Notes
	item	Conditions	min.	typ.	max.	unit	notes
1	Current Consumption		-	-	+1.5	mA	
2	Output Level		0.8	-	-	V_{P-P}	1
3	Symmetry	GND level (DC cut)	40/60	-	60/40	%	
4	Frequency Stability						
	1.Tolerance	After 2 times reflow Ref. to nominal frequency	-	-	±1.5	ppm	2,3
	2.vs Temperature	T_A =-40~+85°C Ref. to frequency (T_A =+25°C)	-	-	±0.5	ppm	
	3.vs Supply Voltage	V _{CC} =+3.0V±5%	-	-	±0.2	ppm	
	4.vs Load Variation	L _{OAD} _R//C=(10kΩ//10 pF)±10%	-	-	±0.2	ppm	
	5.vs Aging	T _A =Room ambient	-	-	±1.0	ppm/year	
5	Start Up Time	@90% of final Vout level	-	-	2.0	ms	
6	Frequency Control						
	1.Control Range	V _{CONT} =+1.5V±1.0V	±9	-	±15	ppm	4
	2.Input Resistance		500	-	-	kΩ	
7	SSB Phase Noise	Relative to f0 level offset 1kHz	-	-	-130	dBc/Hz	

Notes

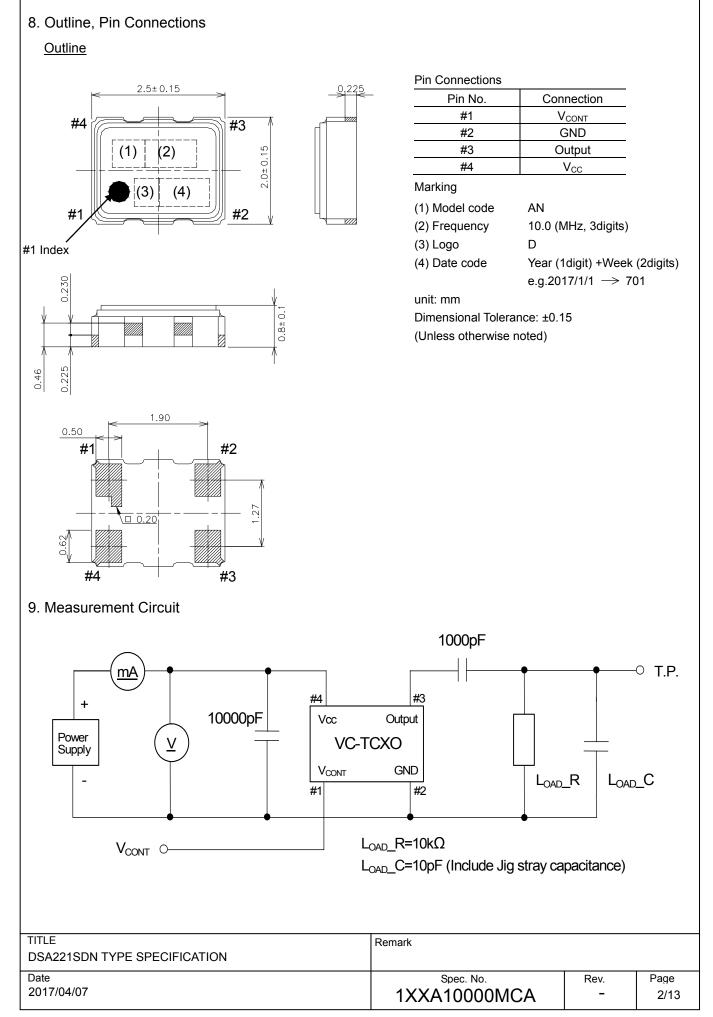
1. Clipped sine wave (DC-coupled)

2. T_A=+25°C

3. Please leave after reflow in 2h or more at room ambient.

4. Positive slope (Frequency becomes high in proportion to frequency control voltage.)

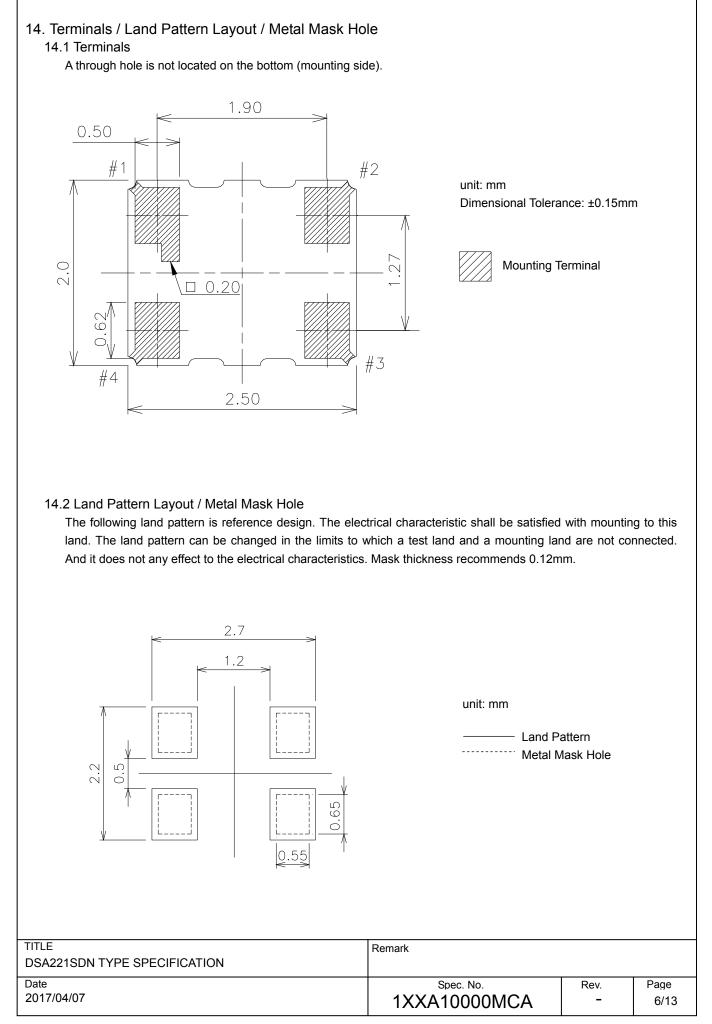
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	Item	Description	lause.13) except 1	Rec	quirements	-		
1	Drop	Natural drop (On concrete)			Juliemento			
	ыор	Mounting on the set or test fixture.(Tota	al woight 100g)					
		-	ii weight 100g)					
		Height : 150cm		df/f=<±1.0p	om			
		Direction : X,Y,Z, 6directions						
		Test cycle : 3cycles						
		Reference specification : EIAJ-ED-470	2A Method5					
2	Vibration	Sweep range : 10~500Hz						
		Sweep speed : 11min/cycle						
		Amplitude : 1.5mm (10~55Hz)						
		Acceleration : 200m/s ² (55~500Hz)		df/f=<±0.5p	om			
		Direction : X,Y,Z, 3directions						
		Test cycle : 10cycles						
		Reference specification : IEC 60068-2	-6					
3	Shock	Acceleration : 1000m/s ²						
-		Direction : X,Y,Z, 6directions						
		Duration : 6ms		df/f=<±0.5p	m			
		Test cycle : 3cycles/each directions		5111				
		Reference specification : IEC 60068-2	27					
4	PCB bend	PWB : t=1.6mm	21					
4								
	strength	Pressure speed : 1.0mm/s		df/f=<±0.5p				
		Bend width : $1 \rightarrow 2 \rightarrow 3$ mm	No visible d	•				
			Duration : 10±1s No leak damage.					
		Reference specification : IEC 60068-2	21 Ue1					
5	Adherence nature	PWB : t=1.6mm						
		Direction : X,Y, 2directions	df/f=<±0.5ppm					
		Pressure : 10N	No visible damage.					
		Duration : 10±1s	No leak damage.					
		Reference specification : IEC 60068-2		C				
6	Package strength	Pressure : 10N		df/f=<±0.5p	om			
o i dokuge strengtri		Duration : 10±1s		No mechanical damage.				
		Reference specification : IEC 60068-2	No leak damage.					
7	Gross leak	It is immersed for 3min into +125±5°C		No Icak dan	lage.			
'	GIUSSIEak			No continuo	us air bubbles			
		Chlorofluorocarbon (CFCs) liquid.	47	No continuo				
		Reference specification : IEC 60068-2						
8	Fine leak	It shall be measured by the helium lea						
		after pressurization for 60min by the p						
		of $(3.92\pm0.49) \times 10^5$ Pa in a helium gas						
		Reference specification : IEC 60068-2						
9	Solderability	Solder bath temperature : +245±5°C		A new unifo	rm coating of s	solde		
		Duration : 3±0.3s		shall cover a minimum of 95%				
		Reference specification : IEC 60068-2	-58	of the surface	e being imme	rsed.		
0	Resistance to	1) Solder iron method			-			
-	soldering heat	Bit size : B(φ3) Bit temperature : +35	0+10°C	df/f=<±0.5ppm				
	eerdening nede	Duration : 3+1/-0s /each terminal	02.00	dV _{OUT} =<±0.				
		It shall be measured after 2h at room t	emnerature	No visible d				
		humidity. Reference specification : IEC			unuge.			
			00000-2-20					
		2) Reflow	1	15/5				
		In refer to temperature profile shown in	clause 13.	df/f=<±1.0pp				
		Test cycle : 3cycles		dV _{OUT} =<±0.				
		It shall be measured after 2h at room t	No visible d	amage.				
		humidity. Reference specification : IEC	60068-2-58					
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11. Environmental Characteristics All test is performed after 3times reflow (Clause13) Item Description Requirements 1 Low temperature Temperature : -40±3°C df/f=<±1.0ppm storage $dV_{OUT} = < \pm 0.2V_{P-P}$ Duration: 1000h It shall be measured after 2h at room temperature. The electrical characteristics humidity. Reference specification : IEC 60068-2-1 Ab are satisfied. 2 High temperature Temperature : +85±2°C df/f=<±1.0ppm storage $dV_{OUT} = < \pm 0.2V_{P-P}$ Duration: 1000h The electrical characteristics It shall be measured after 2h at room temperature, humidity. Reference specification : IEC 60068-2-2 Bb are satisfied. 3 Humidity Temperature : +85±2°C df/f=<±1.0ppm R.H. 85±5% dV_{OUT}=<±0.2V_{P-P} Duration: 1000h The electrical characteristics It shall be measured after 2h at room temperature. are satisfied. humidity. Reference specification : IEC 60068-2-3 HTB 4 Temperature : +85±2°C df/f=<±1.0ppm Duration: 1000h dV_{OUT}=<±0.2V_{P-P} BIAS : Max value of supply voltage The electrical characteristics It shall be measured after 2h at room temperature, are satisfied. humidity. Reference specification : IEC 60068-2-2 Bb 5 THB Temperature : +40±2°C R.H. 90~95% df/f=<±1.0ppm dV_{OUT}=<±0.2V_{P-P} Duration: 1000h The electrical characteristics BIAS : Max value of supply voltage are satisfied. It shall be measured after 2h at room temperature, humidity. Reference specification : IEC 60068-2-3 6 Thermal shock Thermal shock : $-40\pm3^{\circ}C$: 0.5h \Leftrightarrow $+85\pm2^{\circ}C$: 0.5h df/f=<±1.0ppm Test cycle : 200cycles dV_{OUT}=<±0.2V_{P-P} Shift time : 2~3min The electrical characteristics It shall be measured after 2h at room temperature, are satisfied. humidity. Reference specification : IEC pub.68-2-14.Na 7 ESD Model : Machine Model (MM) V=±200V (C=200pF, R=0Ω) df/f=<±1.0ppm Number of times : 3times dV_{OUT}=<±0.2V_{P-P} Each terminal except common terminal. The electrical characteristics (Connect to test terminal) are satisfied Reference specification : EIA/JESD22-A115 Model : Human Body Model (HBM) V=±1500V (C=100pF, R=1500Ω) df/f=<±1.0ppm Number of times : 3times dV_{OUT}=<±0.2V_{P-P} The electrical characteristics Each terminal except common terminal. (Connect to test terminal) are satisfied. Reference specification : EIA/JESD22-A114 TITLE Remark DSA221SDN TYPE SPECIFICATION Date Spec. No. Page Rev. 2017/04/07 1XXA10000MCA 4/13

12. Flatness of Termin When the component	nal is placed on the flat surface, the gap	from the connecting terminal shall no	ot exceed 0.05	mm.
		Gap : 0.05mm max.		
13. Reflow Profile		•		
Temperature	+260°C +220°C +160~+180°C 1			
	Time			
	1Preheat+1602Primary Heat+2203Peak+260			
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Label

free

15. Packing Condition

- 15.1 Taping package
 - (1) Emboss tape format and dimensions See Fig.1
 - (2) Quantity on reel
 - 3000pcs. max. / reel (3) Taping specification
 - See Fig.2
 - No lack of a product. (4) Reel specification
 - See Fig.3
 - (5) Taping material list See right table.

15.2 Packing

The products packed in the antistatic bag.

*Moisture sensitivity level : IPC/JEDEC Standard J-STD-033 / Level 1

No dry pack required and baking after re-storage is unnecessary.

15.3 Packing box

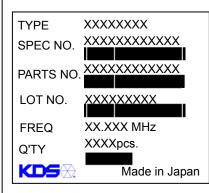
Max 10 reels/packing box. However, in the case of less than 10 reels, It is contained by any boxes. The space in a box is fill up with a cushion.

15.4 Label detail

A Lot label is put on a reel and a shipping label and Pb-Free label is put on a packing box.

Lot label		Shipping label		Pb-free
TYPE(Model NatSPEC NO.(Spec. NuPARTS NO.(User's PatLOT NO.(Lot NumbFREQ.(Nominal FQ'TY(Quantity)KDSDAISHINK	mber) arts Number) er) requency)	ITEM SPEC DELIVERY DATE Q'TY NOTES DAISHINKU CORP	(Model Name) (Spec. Number) (Delivery Date) (Quantity) (User's Parts Number)	Pb-1

Lot label (Example)



Formation of a lot number

e.g. AH7101001			
<u>A</u>	<u>_H_</u>	7101	001
Manufacturing site code	Product code	year/ month/ day	Serial No.

The notation method of a manufacture year, month, and day. (4digits alphanumeric character)

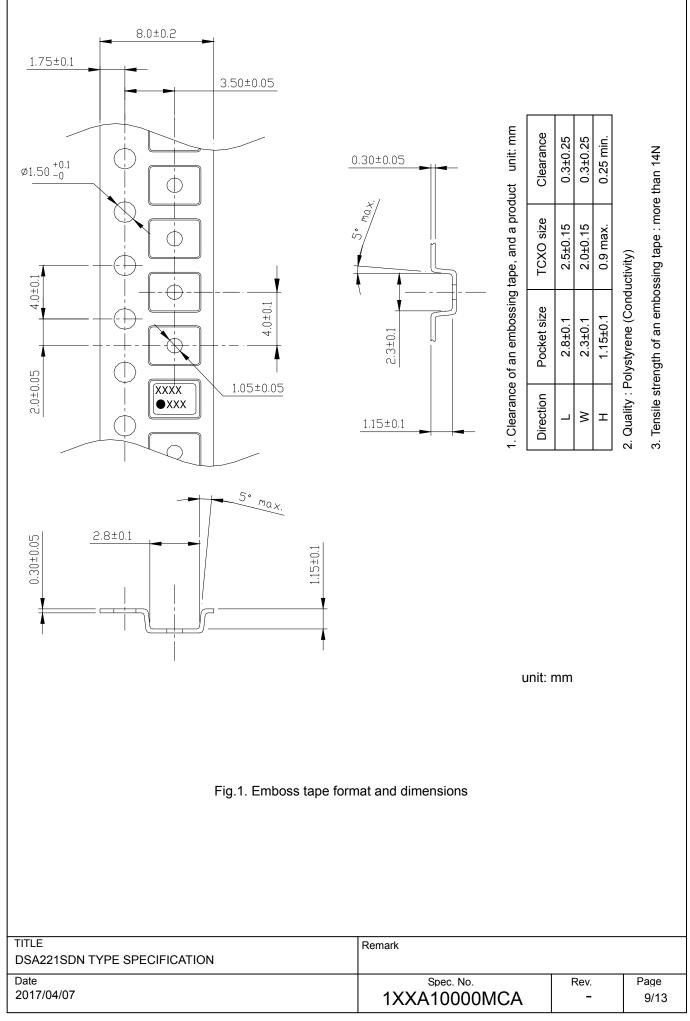
<u>YMDD</u> (4digits)			ts) e	.g.) 20	1 <u>7</u> /0 <u>1</u>	<u>/01</u> →	7101					
<u>Y</u> Year			1	digit (l	_ast di	git of Y	′ear)					
<u>M</u> M		Month	ו ו	digit a	Iphanu	imeric	symbo	ol				
<u>DD</u> Day			2	digits	numer	ical ch	aracte	rs of d	ay			
Month	Jan.	Feb.	Mar.	Apr.	May.	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.
Symbol	1	2	3	4	5	6	7	8	9	0	Ν	D

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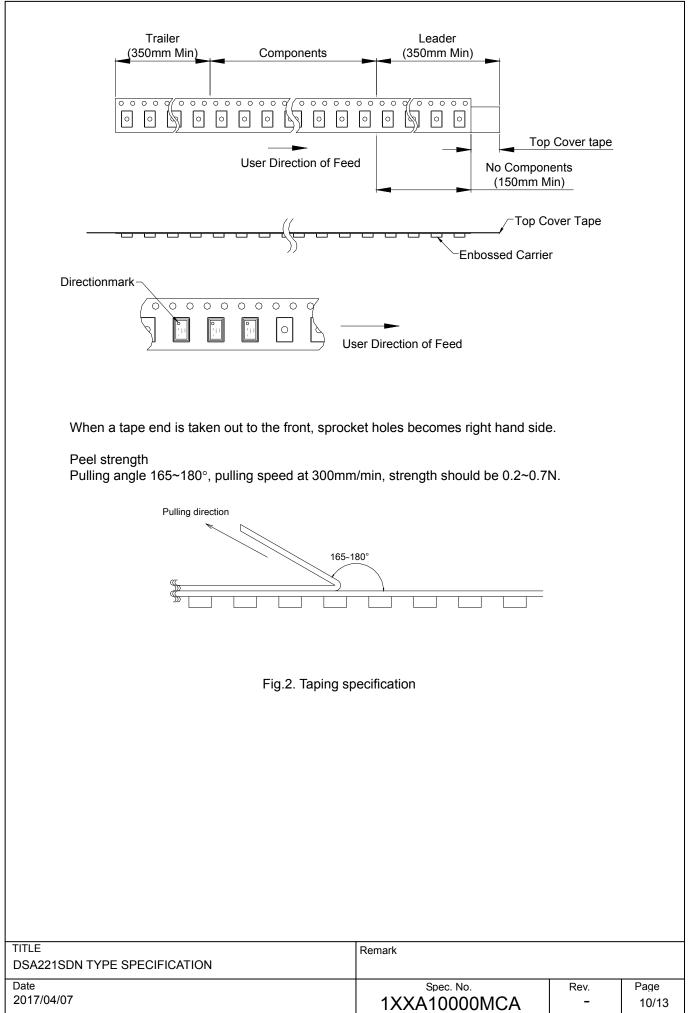
DAISHINKU CORP.

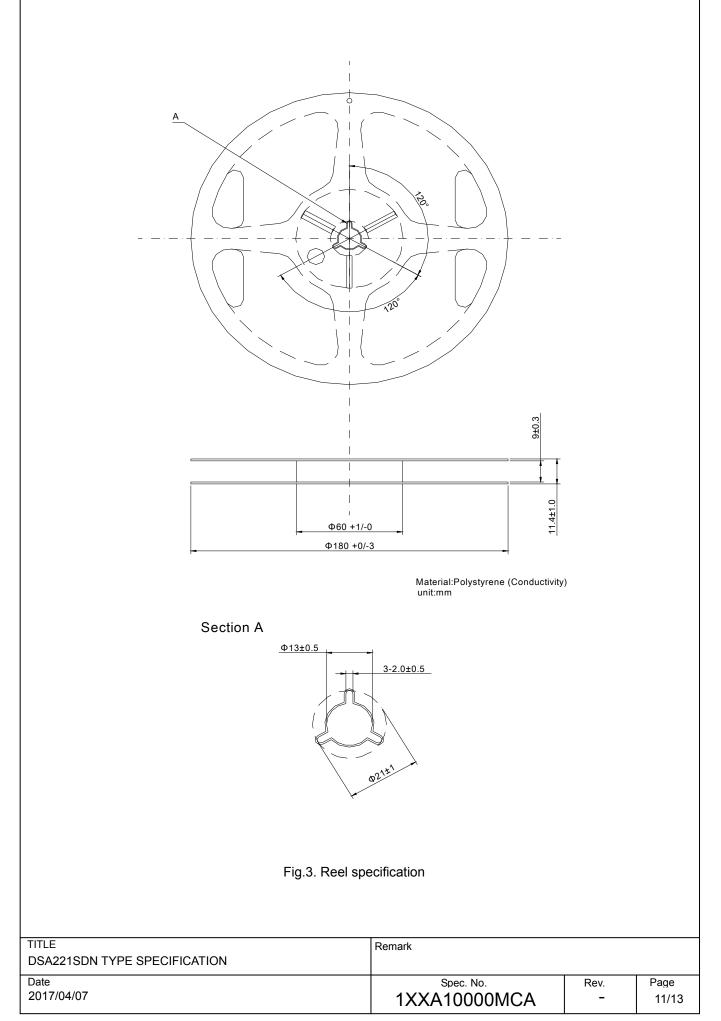
<u>Taping material List</u> Cover Tape : PET + Olefin Resin (Conductivity) Emboss : PS (Conductivity) Reel : PS (Conductivity)

Lot Label				
	Air Cush	ion		
Antistatic Bag				
\bigcirc	Pb-free L	abel		
	Shipping			
The product is packed up with the method which	h does not	break in the handling by a shippin	g agent.	
LE		emark		
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DM-Z0002: Style-010 Ver.1





16. Notes on mounting and handling

16.1 Storage environment

- (1) The temperature and humidity of a storage place, Please give +5~+40°C and 40~85% as a standard.
- (2) Please use this product within one year from the packing label date of issue.
- (3) Please avoid the place which generates corrosive gas, and the place with much dirt.
- (4) Please keep it in a place with little temperature change.
- Dew condensation arises owing to a rapid temperature change and solderability becomes bad.
- 16.2 Be cautions to static electricity and high voltage.
- 16.3 This product has sufficient durability to fall and vibration. However, conditions may change to the fall after mounting to a PWB, and vibration. When you should drop on a floor the PWB which mounted the product or too much shock is added. Please use after a performance check.
- 16.4 Please check that the curvature of the substrate at the time of substrate cutting does not affect product. Moreover, especially when a product is near the position of a PWB guide pin, and the position of PWB break, be careful.
- 16.5 The part concerned does not correspond to washing.
- 16.6 Please repair at +260°C in 10s with hot air or +350°C in 5s with solder Iron.

17. Mandatory control

17.1 Ozone-depleting substance

It regulates by the U.S. air purifying method (November, 1990 establishment). ODS of CLASS1 and CLASS2 is not contained or used.

17.2 PBDE, PBBs

PBDE, PBBs are not contained into all the material currently used for this product.

17.3 RoHS

Following material restricted by RoHS (2011/65/EU) is not included or used. Lead, mercury, cadmium, hexavalent, chromium ,PBB and PBDE.

17.4 Law Concerning Examination and Regulation of Manufacture, etc. of Chemical Substances

All the material currently used for this product is based on "Law Concerning Examination and Regulation of Manufacture, etc. of Chemical Substances". It is a registered material.

17.5 Lead

Leads, such as solder, are not used for this product. (Lead Free)

17.6 About the existence of silver and mercury use

The silver of very small quantity is contained in the conductive adhesives used for adhesion of Blank. Moreover, mercury is used. It does not get down.

18. The country of origin / factory name / address

Japan
DAISHINKU Corp. Tottori Production Div.
7-3-21 Wakabadai minami, Tottori 689-1112

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2017-0311 REVERSION RECORD

Rev. No.	Date	Reason	Contents	Approved	Checked	Drawn
-	2017/04/07	-	Initial Release	T.Soga	T.Soga	E.Kameda